

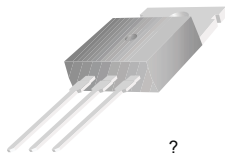
# 3205

## product description

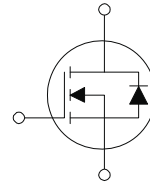
FHP3205 is a low-voltage high-current power MOS field effect transistor, widely used in power inverters

## Features

110A, 55V,  $R_{DS(on)} = 8.0m\Omega$  fast switching speed



Available  
**RoHS\***  
COMPLIANT



## Limit value (TC=25°C)

parameter name	symbol	Parameter value	unit
Drain-source voltage	$V_{DS}$	55	V
Drain current @Tc=25°C	$I_D$	110	A
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Dissipated power @Tc=25°C	$P_D$	200	W
Junction temperature	$T_J$	175	°C
Storage temperature	$T_{stg}$	-55 ~ 175	°C
avalanche	$E_{AS}$	20	mJ

## Dynamic characteristic value

Parameter Description	symbol	Test Conditions	Minimum value	Typical value	maximum	unit
Input capacitance Output	$C_{iss}$	$V_{DS}=25v, V_{GS}=0v, f=1.0 MHz$	--	3247	--	pF
capacitance Reverse	$C_{oss}$	$V_{DS}=25v, V_{GS}=0v, f=1.0 MHz$	--	781	--	pF
transmission capacitance	$C_{rss}$	$V_{DS}=25v, V_{GS}=0v, f=1.0 MHz$	--	211	--	pF

	$B_{V_{DS}}$	$V_{GS}=0V, I_D=250\mu A$	55	--	--V	
	$I_{DSS}$	$V_{DS}=55V, V_{GS}=0V$	--	--	25	$\mu A$
	$I_{GSS(F/R)}$	$V_{GS}=20V, V_{DS}=0V$	--	--	100	nA
	$R_{DS(ON)}$	$V_{GS}=10V, I_D=62A$	--	--	8.0	
	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	--	4.0 V	
	$g_{FS}$	$I_D=62A, V_{DS}=25V$	44	--	--S	

	$Q_g$	$V_{DS}=44V$ $I_D=62A$ $V_{GS}=10V$	--	--	146	nC
	$Q_{gs}$		--	--	35	nC
	$Q_{gd}$		--	--	54	nC

( )	$T_d(on)$	$V_{DD}=28V$ $I_D=62A$ $R_G=4.5?$ $V_{GS}=10V$	--	14	--	ns
	$T_r$		--	101	--	ns
	$T_d(off)$		--	50	--	ns
	$t_f$		--	65	--	ns

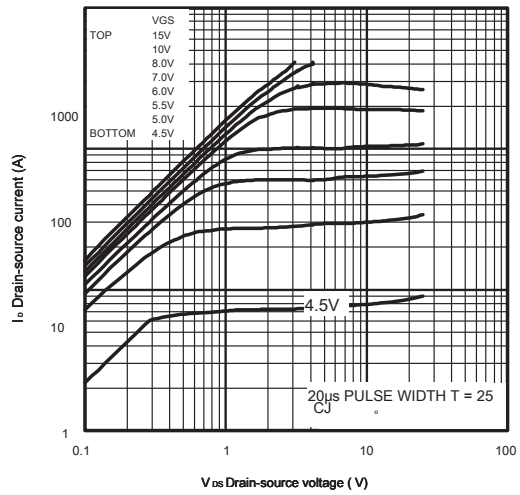


Fig 1. Output characteristics

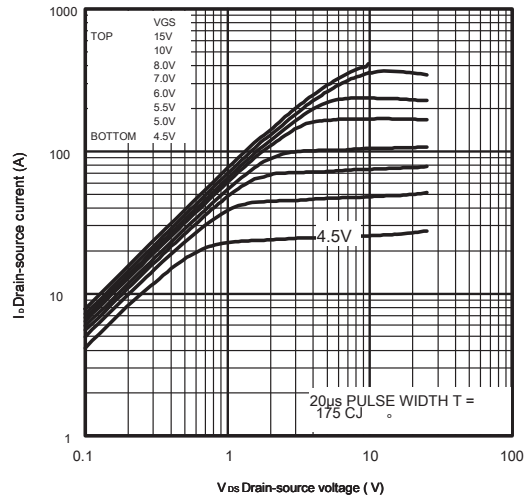


Fig 2. Output characteristics

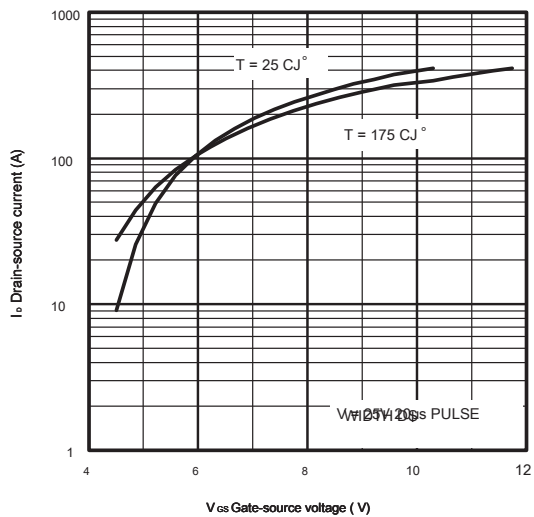


Fig 3. Change characteristics

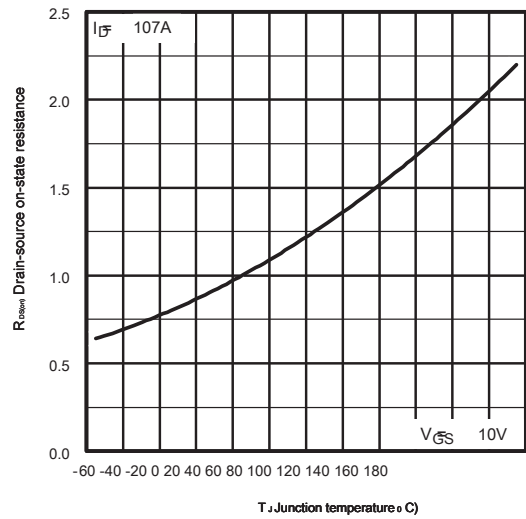


Fig 4. On-state resistance vs. temperature

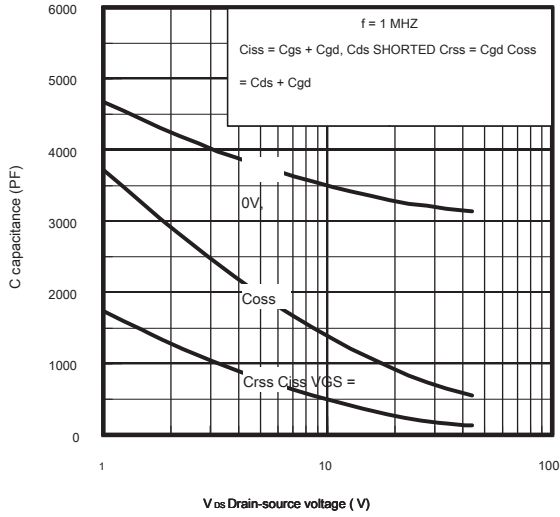


Fig 5. Relationship between capacitance and drain-source voltage

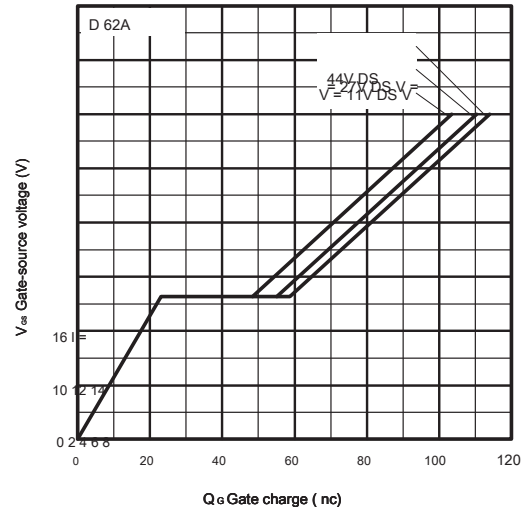


Fig 6. Gate charge vs. gate-source voltage

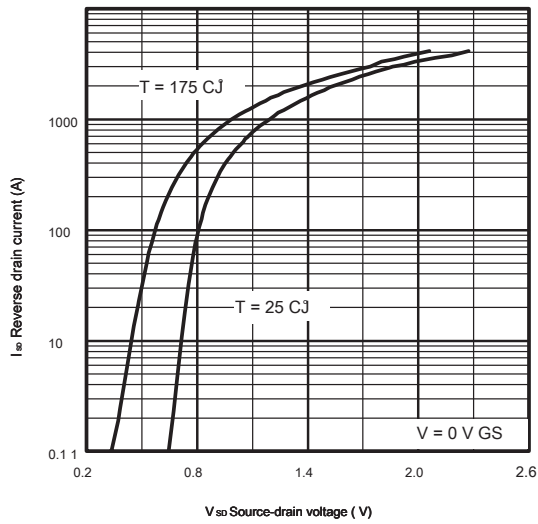


Fig 7. Source-drain diode forward characteristics

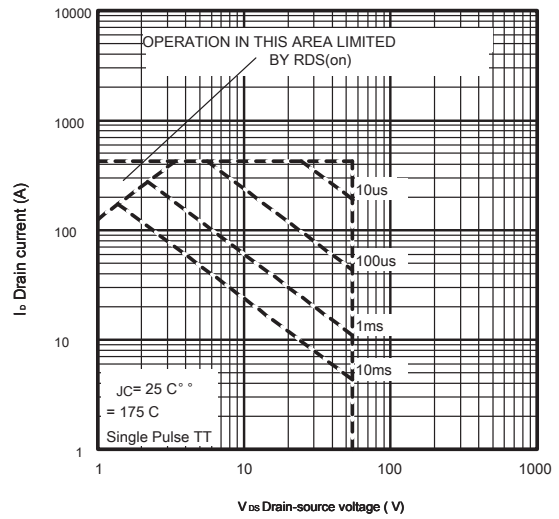


Fig 8. Maximum safe use range

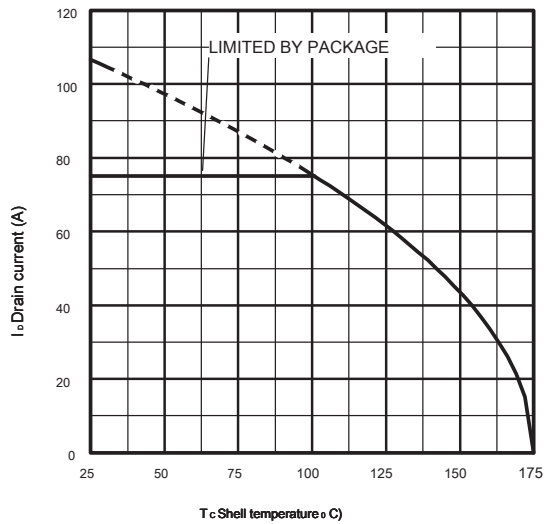


Fig 9. Relationship between maximum drain capacitance and case temperature

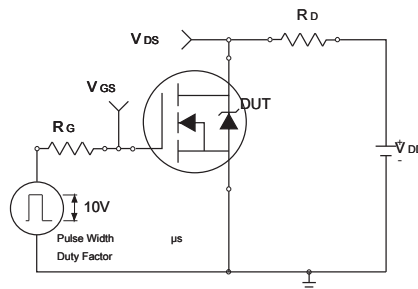


Fig 10a. Switch test circuit

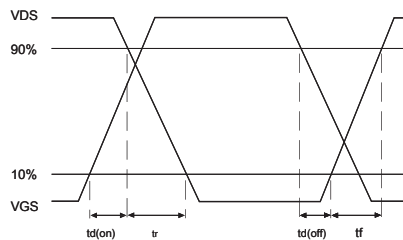


Fig 10b. Switching time waveform

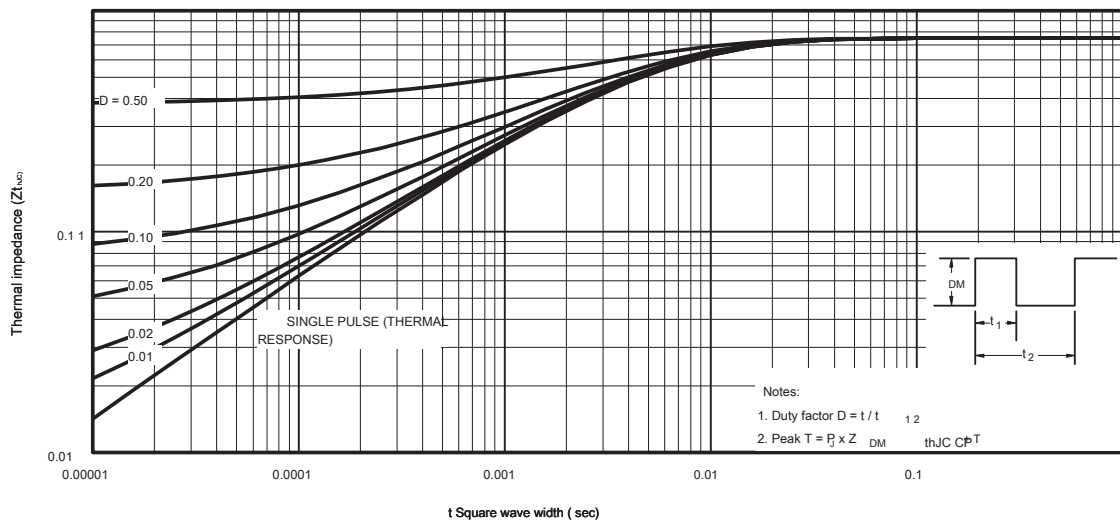


Fig 11. Maximum thermal impedance change

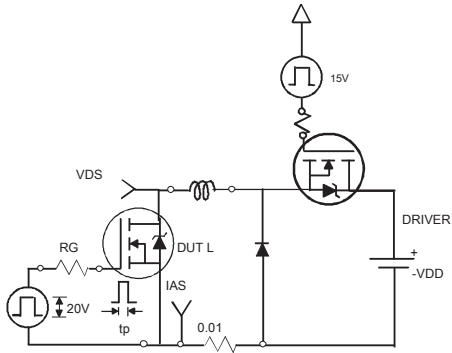


Fig 12a. Unlimited inductance test circuit

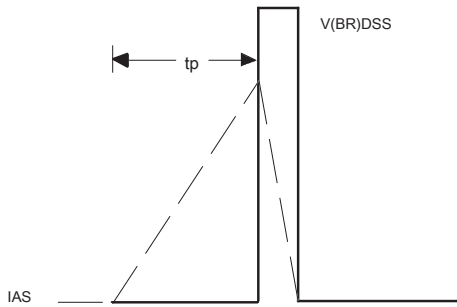


Fig 12b. Test waveform

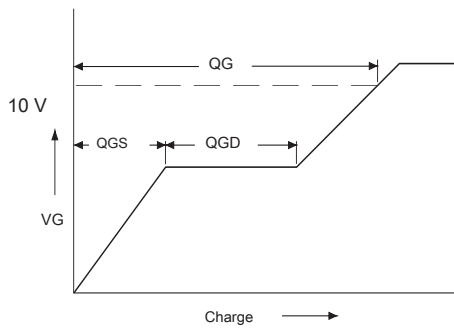


Fig 13a. Gate charge curve

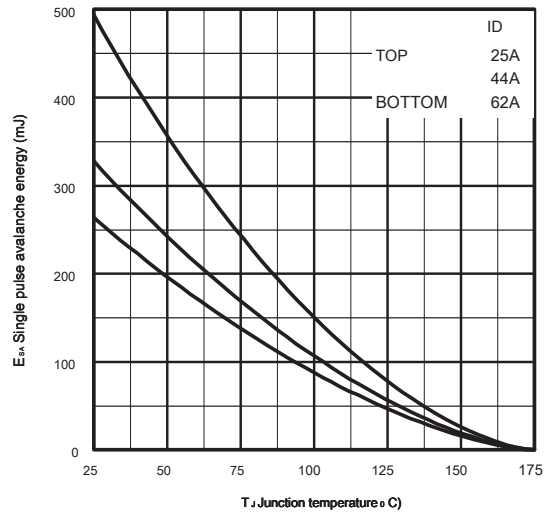


Fig 12c. Relationship between maximum avalanche energy and drain current

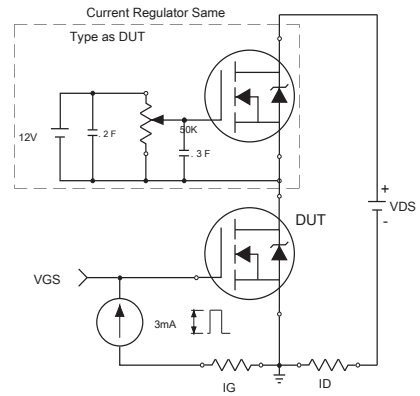
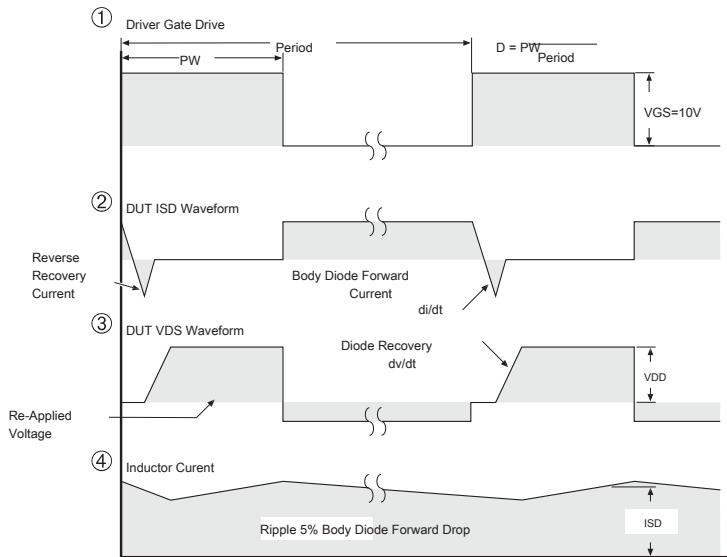
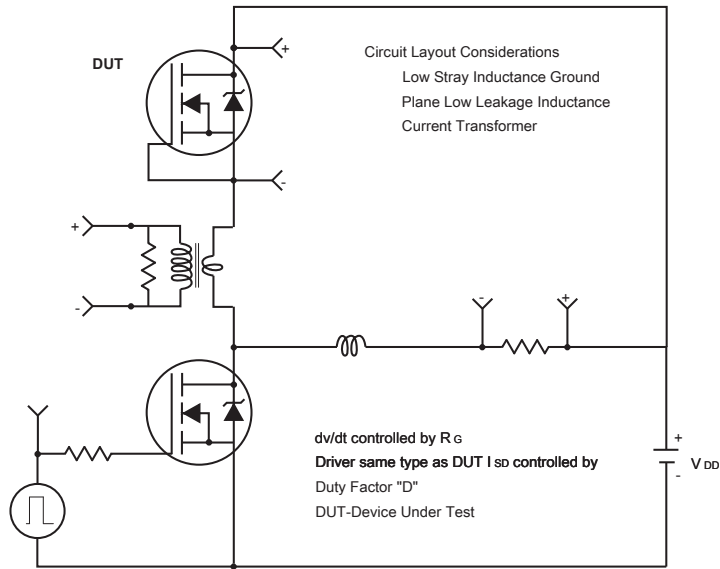


Fig 13b. Gate charge test circuit

Diode reverse recovery characteristics dv/dt Test circuit

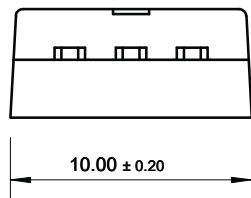
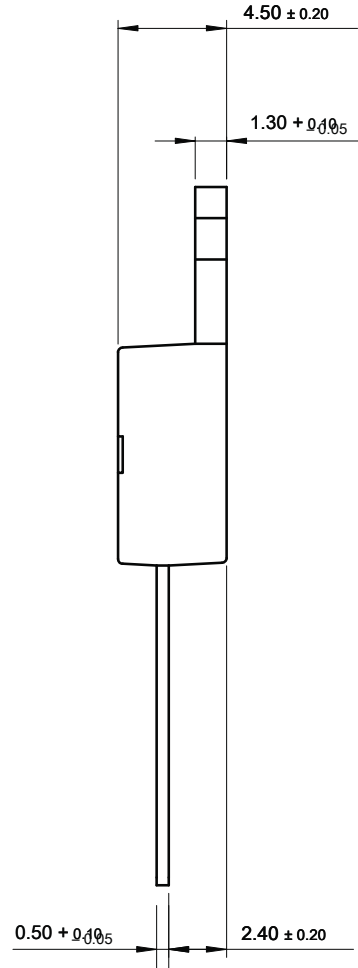
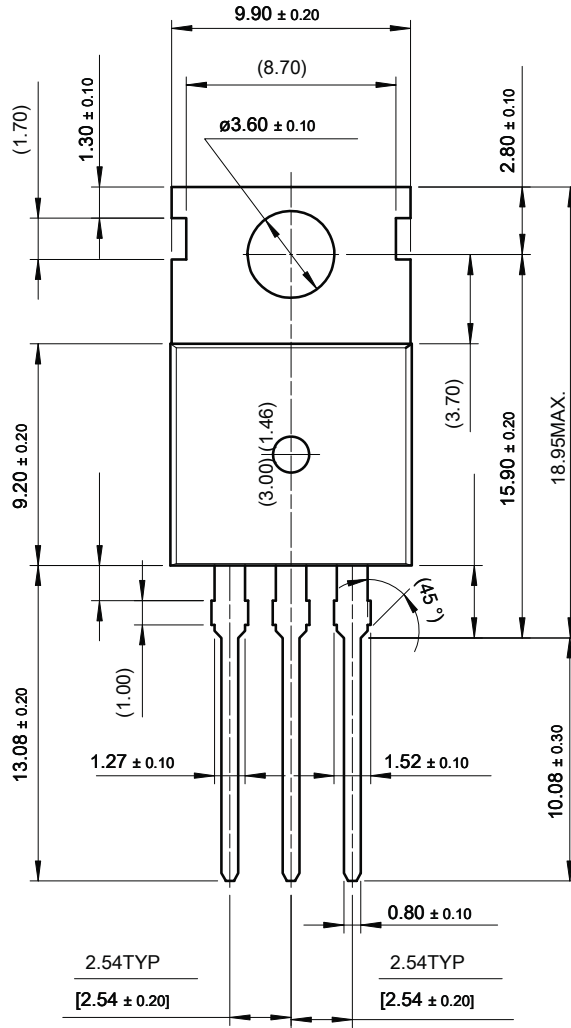


\*  $V_{GS} = 5V$  for Logic Level Devices  $R_g$

Fig 14. Test waveform

Dimensions

3 ???



Dimensions: mm